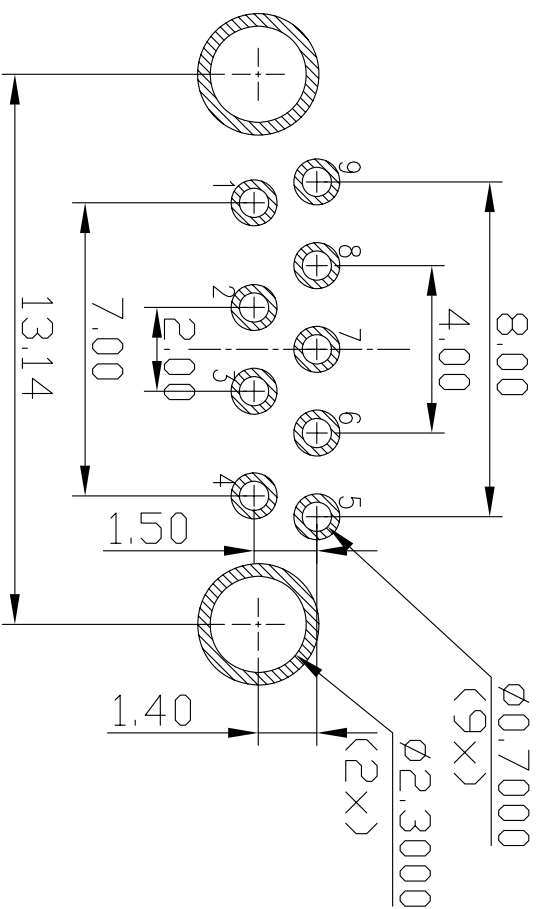
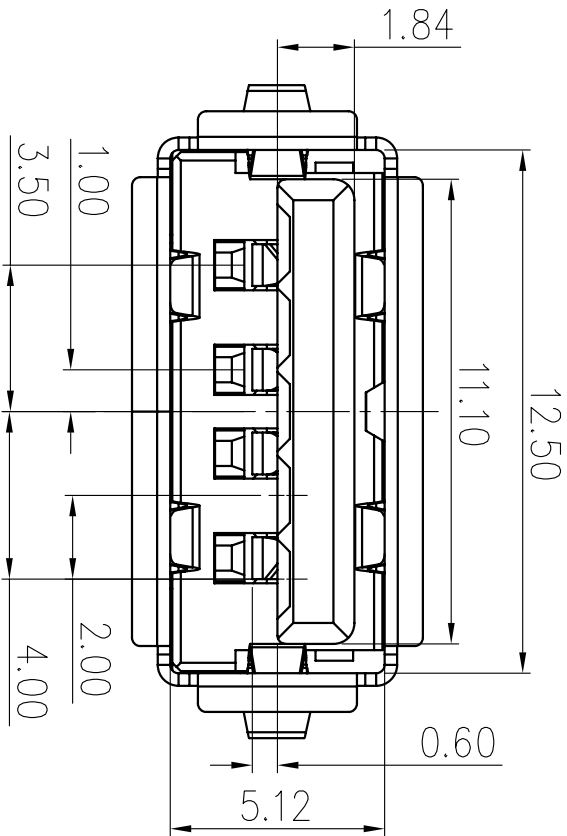
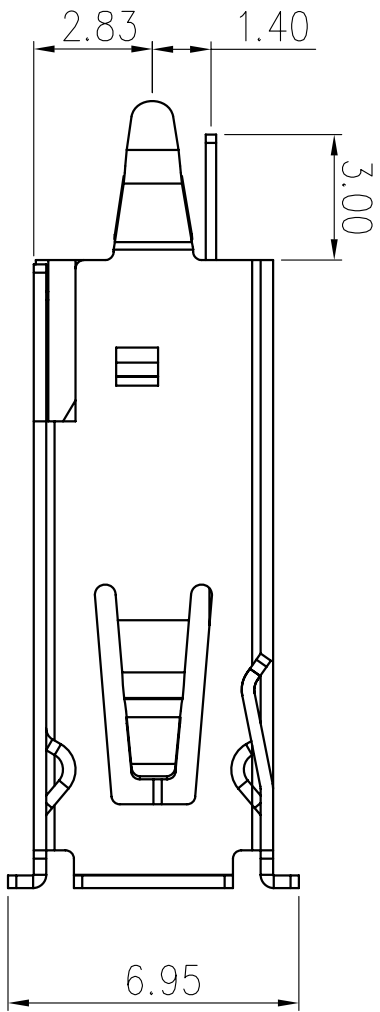
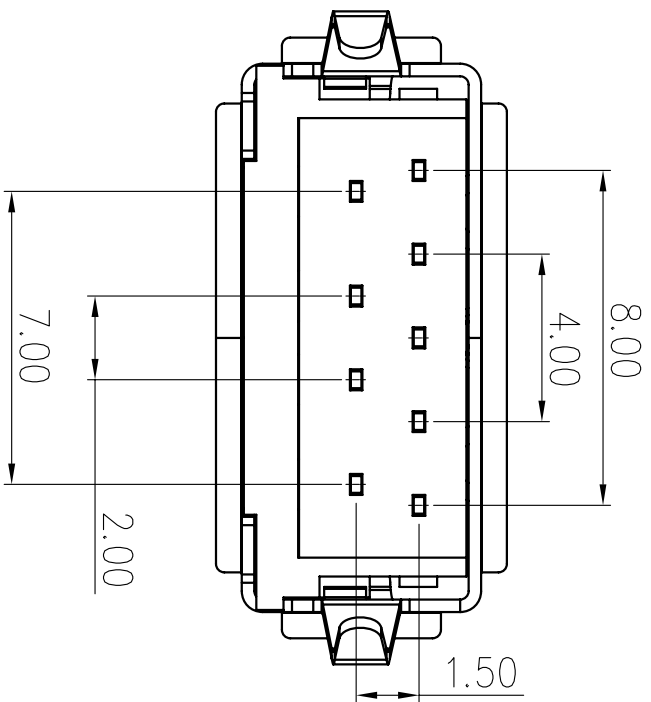
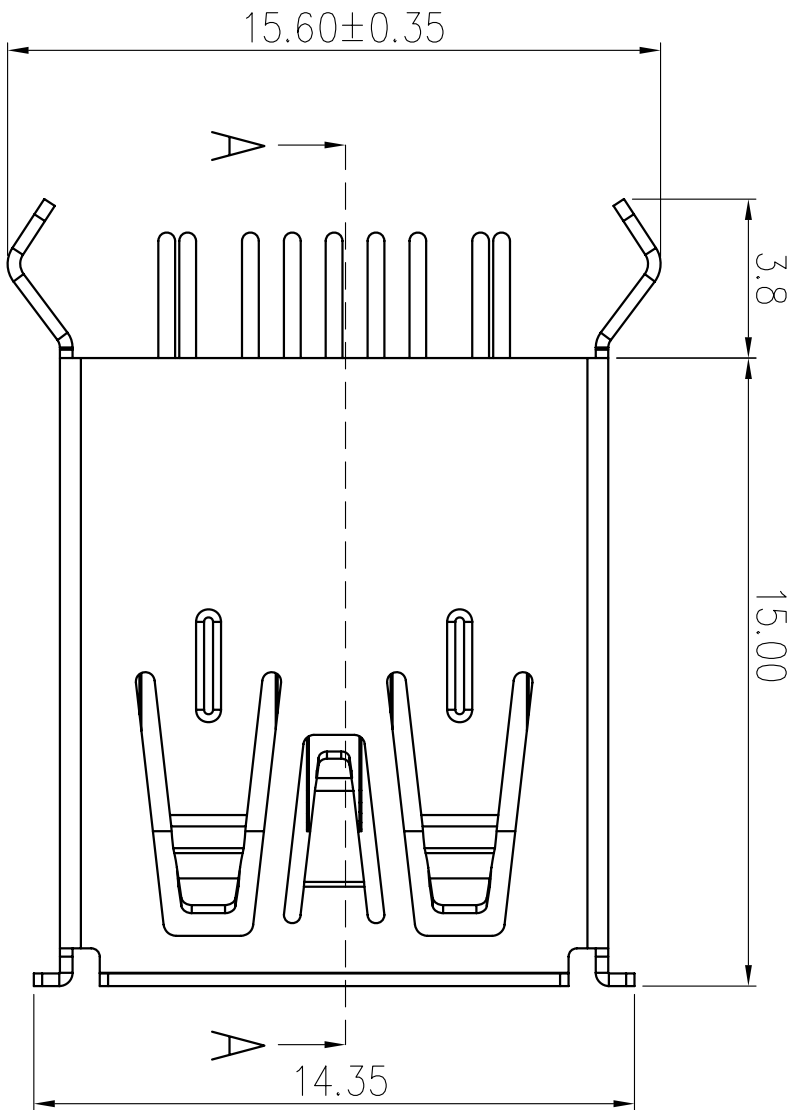


ECN NO.		ECN DESCRIPTION		REV.	DATE	APPD.
/		新版发行		A	2014.12.18	




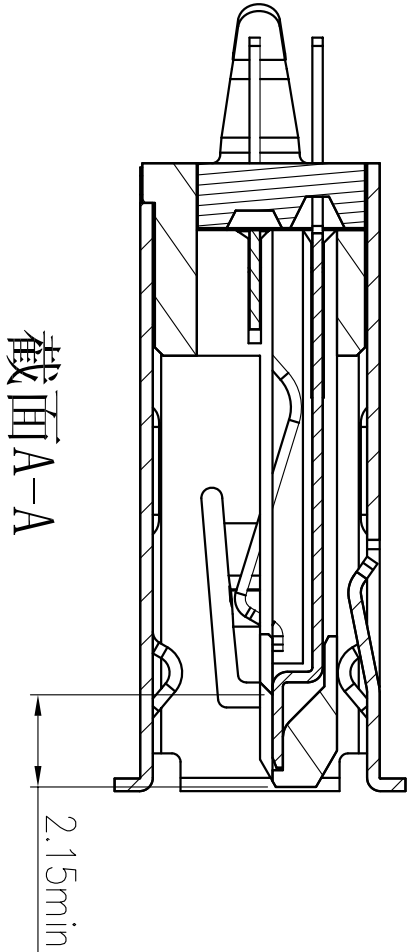
REFERENCE PCB LAYOUT

- Remark:
- 1.MATERIAL:
- 1.1 Housing:thermoplastic plastics.
 - 1.2 terminals:Copper Alloy
 - 1.3 Front Shell:Copper Alloy/SPCC.
- 2.characteristics:
- 2.1 Rating Voltage : 30V AC.
 - 2.2 Rating Current:PIN1&PIN4(Vbus&Correponding ground PIN)
 - 1.8A MAX Other PINS 0.25A min.
 - 2.3 Contact Resistance:PIN1&PIN4:30 mΩ MAX. Other PINS: 50 mΩ
 - 2.4 Insulation Resistance:100 MΩ MIN.
 - 2.5 Withstanding Voltage:AC 100V between adjacent contacts
 - 2.6 Mating force: 3.57Kgf MAX(35N MAX)
 - 2.7 Extraction force:1Kgf Min(9.8N Min)
 - 2.8 Life test:1500Cycles MIN.
 - 2.9 Temperature Range: −30℃~+80℃.

- U323-012X-XXX0X1
- 1:Iron alloy
 - Ni plating
 - 5:Copper alloy
 - Ni plating
 - 1:Au 1u”
 - 3:Au 3u”
 - 5:Au 5u”
 - 7:Au 10u’
 - 8:Au 15u”
 - A:Au 30u”
 - 1:tray
 - 2:Tube
 - 8:Tape&Reel
 - 9:Tape&Reel+Mylar
 - 1:Black
 - 7:Blue 300C
 - 8:Blue 300C-1
 - C:Blue 300C-2
 - E:Blue 300C-3
 - 1:PA66
 - 2:PBT
 - 6:LCP

TOLERANCE UNLESS OTHERWISE SPECIFIED		HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.	
.XXX ±0.10	.X’ ±2’	HLW 深圳市华联威电子科技有限公司	
.XX ±0.20	.XX’ ±1’		
.X ±0.30			

APPROVED		PART NAME:	USB 3.0 AF 180度				
CHECKED		PART No:	U323-012X-XXX0X1				C
DRAWED	Hexing	PROJECTION:	UNIT:	SCALE	SHEET	REV.	
DATE	2014.12.18		mm	1:1	10F1	A	



截面A-A